



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Bayot  
Serial No: 09/963,493  
Filed: 9/27/2001

Docket No: TI-33474  
Examiner: Coleman, William  
Art Unit: 2823

For: METHODS OF AND APPARATUS FOR MANUFACTURING BALL GRID  
ARRAY SEMICONDUCTOR DEVICE PACKAGES

APPEAL BRIEF PURSUANT TO 1.192(c)

*Del Only*

Assistant Commissioner for Patents  
Washington, DC 20231

Dear Sir:

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(A)  
I hereby certify that the above correspondence is being  
deposited with the U.S. Postal Service as First Class Mail in  
an envelope addressed to: Assistant Commissioner for  
Patents, PO Box 1450, Alexandria, VA 22313-1450 on  
5-21-04.

*Tommie Chambers*

Tommie Chambers

The following Appeal Brief is respectfully submitted in triplicate and in connection  
with the above identified application in response to the Final Office Action mailed October  
16, 2003.

REAL PARTY IN INTEREST

The real party in interest is Texas Instruments Incorporated.

RELATED APPEALS AND INTERFERENCES

Appellants legal representative knows of no appeals or interferences which will be  
directly affected or have a bearing on the Board's decision.